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Planning

DLSPIN2008 - Circuit Boards, Backplanes and Power Electronic Modules

Diamond Light Source Ltd

F01: Prior information notice

Prior information only

Notice identifier: 2023/S 000-027040

Procurement identifier (OCID): ocds-h6vhtk-03fc47

Published 13 September 2023, 10:25am

Section I: Contracting authority

I.1) Name and addresses

Diamond Light Source Ltd

Harwell Science and Innovation Campus

Didcot

OX11 0ED

Contact

Debbie Pryor

Email

procurement@diamond.ac.uk

Telephone

+44 1235567575

Country

United Kingdom

Region code

UKJ14 - Oxfordshire

Companies House

4375679

Internet address(es)

Main address

<https://www.diamond.ac.uk>

I.3) Communication

Additional information can be obtained from the above-mentioned address

I.4) Type of the contracting authority

Body governed by public law

I.5) Main activity

Other activity

Scientific Research

Section II: Object

II.1) Scope of the procurement

II.1.1) Title

DLSPIN2008 - Circuit Boards, Backplanes and Power Electronic Modules

Reference number

DLSPIN2008

II.1.2) Main CPV code

- 31711100 - Electronic components

II.1.3) Type of contract

Supplies

II.1.4) Short description

Circuit boards and power modules of various types will be required, built to DLS drawings and information. The contract will include the purchase of all components, bare board production, board assembly including front panels and heatsinks. Some testing using test rigs provided by DLS may be required for some boards. The production of the boards and modules will be split over several contracts. Individual board quantities will be from several hundred up to about 1000.

II.1.6) Information about lots

This contract is divided into lots: No

II.2) Description

II.2.3) Place of performance

NUTS codes

- UKJ14 - Oxfordshire

II.2.4) Description of the procurement

Circuit boards and power modules of various types will be required, built to DLS drawings and information. The contract will include the purchase of all components, bare board production, board assembly including front panels and heatsinks. Some testing using test rigs provided by DLS may be required for some boards. The production of the boards and modules will be split over several contracts. Individual board quantities will be from several hundred up to about 1000.

II.3) Estimated date of publication of contract notice

30 September 2024

Section IV. Procedure

IV.1) Description

IV.1.8) Information about the Government Procurement Agreement (GPA)

The procurement is covered by the Government Procurement Agreement: Yes